Security code: 6266

Financial Announcement

FY2021 Ended September31, 2021

November 12, 2021 TAZMO Co., Ltd.



Company Info

Head office

Company name TAZMO Co., Ltd.

Established February 26, 1972

Head office 5311, Haga, Kita-ku, Okayama-shi, Okayama 701-1221, Japan

Capital ¥2,724 Billion

Employees Non-consolidated: 360

Consolidated: 1,096

(as of June 30, 2021)

Business Development, Manufacturing and Sales of

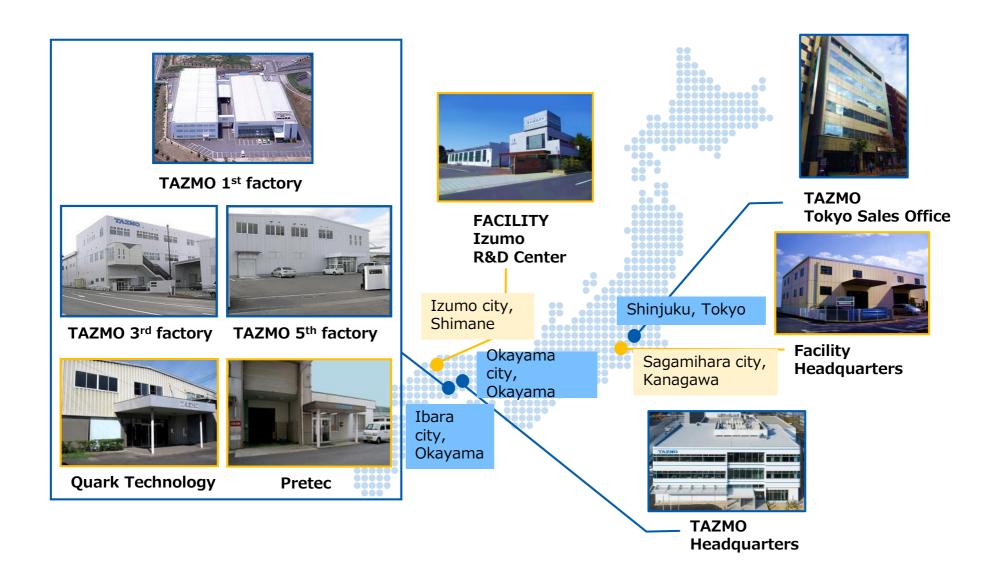
Content Semiconductor Manufacturing Equipment,

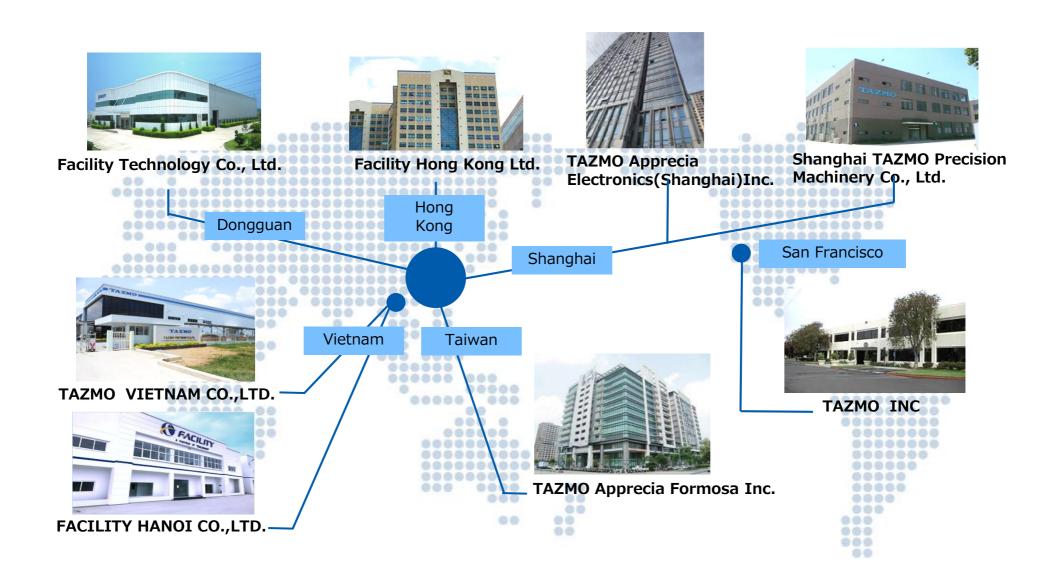
Clean Transfer System, LCD Manufacturing Equipment,

UV Laser Equipment, Plating Equipment, Mold • Resin Molding,

Plating/Circuit formation Equipment for PCB







1972	TAZMO Co., Ltd. is incorporated to manufacture and produce electronic components and repair industrial equipment.
1980	Began production of molding dies, including injection molding dies.
	Completed development of Fully-automated Photo Resist Coater; production and sales started.
1989	Developed TFT Full-color filter manufacturing system; production and sales started.
1990	Constructed new head office/plant at 6186 Kinoko-Cho, Ibara, Okayama
	Developed and produced Ultra Compact Transfer System for Super Clean Room.
1994	Began production and sales of Emboss Carrier Tape.
1995	Began production of injection Molding Products.
2001	Developed "CS13" series Photo Resist Coater specialized for a thicker film application; production and sales started.
2004	Listed on the JASDAQ market.
2008	Established TAZMO VIETNAM CO., LTD. a consolidated subsidiary, in Ho Chi Minh City, Vietnam.

2009	Developed 10 th generation compatible full-color filter manufacturing system; production and sales started.
	Concluded a license agreement with 3M(USA) for semiconductor manufacturing equipment.
2013	Apprecia Technology Inc. became our wholly owned subsidiary company.
	VIETNAM CO., LTD. Constructed new factory at Long Hau Industrial Park in Long An Province, Vietnam.
2015	Capital increased to 1,616,830,000 yen through third-party allocation of shares.
2017	Facility Co., Ltd. and Quark Technology Co., Ltd. became our wholly owned subsidiary company.
2018	[March] Listed on the Second Section of the Tokyo Stock Exchange
	【September】Listed on the First Section of the Tokyo Stock Exchange
2019	Constructed a new head office at 5311 Haga Kita-ku, Okayama-shi, Okayama
2020	Merged with Apprecia Technology Inc.

Semiconductor Manufacturing Equipment Business Unit

Development, Manufacturing and Sales of chemical Coating • Develop equipment and Temporary Bonding • De-bonding equipment for Silicon Thinning used for Semiconductor Manufacturing





Transfer Business Unit

Development, Manufacturing and Sales of silicon wafer Transfer robot, Pre-aligner and customized unit of these components used for Semiconductor Manufacturing Equipment.





Cleaner Business Unit

Development, Manufacturing and Sales of Silicon Wafer Cleaner, Slurry Distribution system and Phosphoric Acid Reclaim System used for Semiconductor Manufacturing.







Coater Business Unit

Development, Manufacturing and Sales of chemical coating system for glass substrate like Liquid Crystal Display(LCD)





Precision molding dies and moldings business

Manufacture and sale of injection molds for electronic equipment parts, resin molded products such as connectors using the injection molds, and embossed carrier tapes





Surface treatment equipment business

Development, Manufacturing and Sales of Plating/Circuit formation Equipment for Printed Circuit Board.

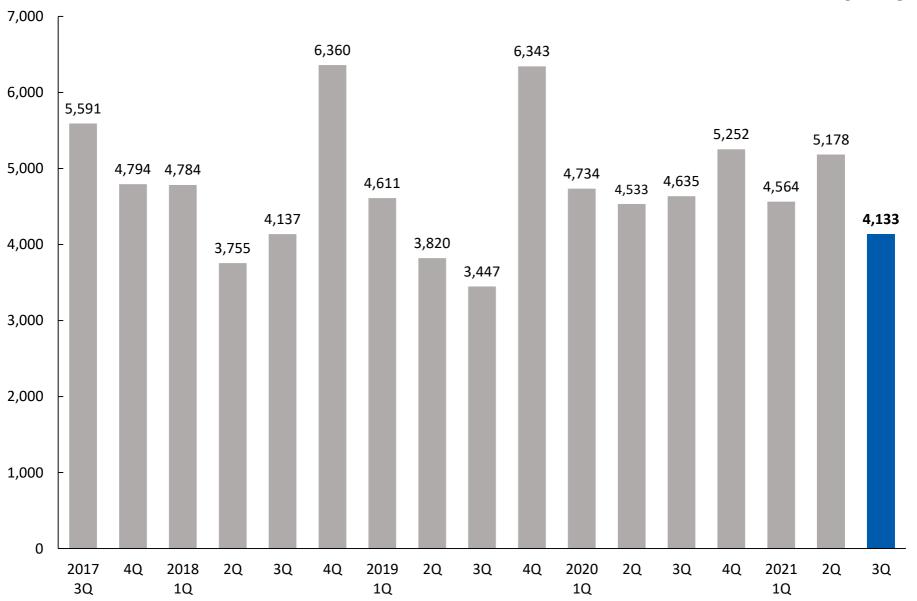




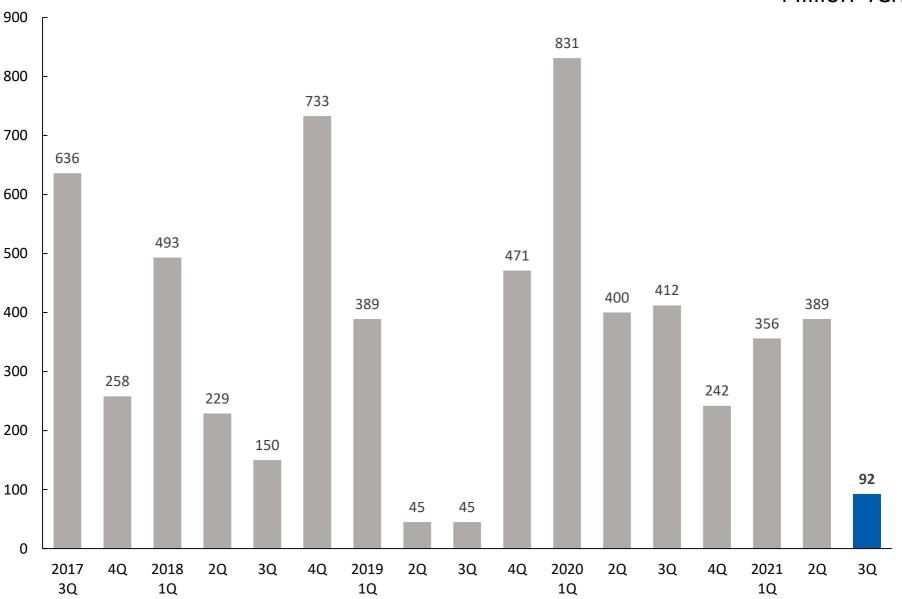


	FY2020 3Q	FY2021 3Q	Sales ratio (%)	Estimates	Achievement ratio (%)
Net sales	14,264	13,876	_	22,749	61.0
Gross profit	4,126	3,575	25.8	_	_
SG&A expenses	2,482	2,736	19.7	<u> </u>	_
Operating income	1,644	838	6.0	2,105	39.8
Ordinary income	1,620	927	6.7	2,160	42.9
Net income	1,199	620	4.5	1,553	40.0









Consolidated B/S



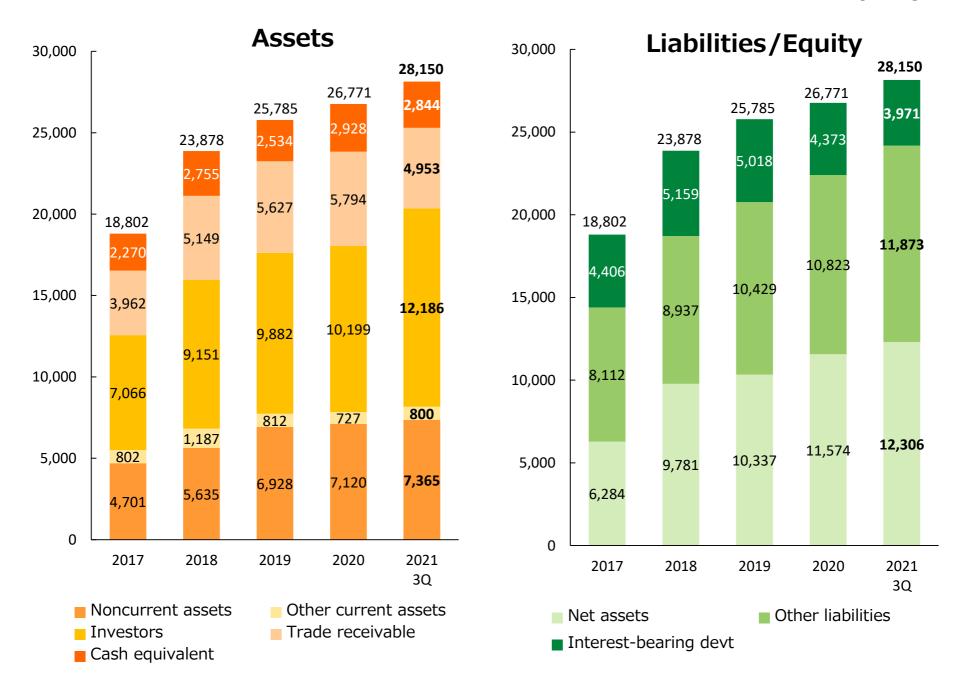
	FY2020	FY2021 3Q	Changes
Current assets	19,650	20,784	1,134
Property, plant and equipment	5,788	5,838	50
Intangible assets	171	151	△19
Investments and other assets	1,160	1,375	214
Total assets	26,771	28,150	1,379
Current liabilities	12,154	13,515	1,360
Noncurrent liabilities	3,042	2,329	△713
Net assets	11,574	12,306	731
Equity ratio	42.6%	43.0%	0.4%

Consolidated B/S Major changes



Major changes						
Assets						
	FY2021 3Q	vs. FY2020				
Cash and deposits	2,844	△84				
Notes receivable trade/Accounts receivable trade	3,583	169				
Electronically recorded monetary claims-operating	1,369	△1,010				
Inventories	12,186	1,987				
Liabilities						
	FY2021 3Q	vs. FY2020				
Notes payable-trade/Accounts payable-trade	1,806	350				
Current portion of bonds	300	300				
Accounts payable	973	△210				
Advances received	5,462	752				
Long-term loans payable	1,644	△380				





Segment information



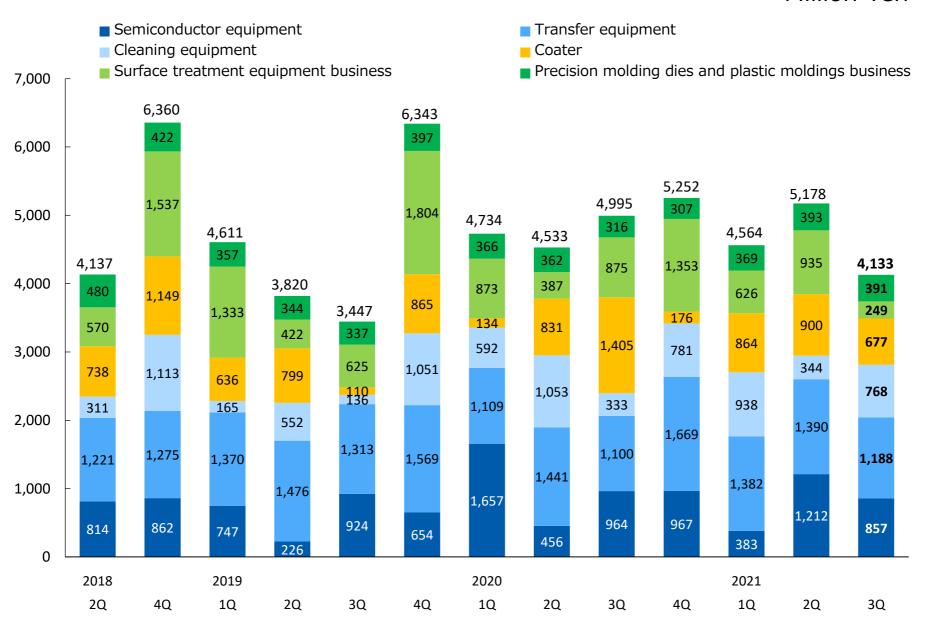
	FY2020 3Q	Sales ratio (%)	FY2021 3Q	Sales ratio (%)	Estimates	Achievement ratio (%)
Net sales	14,264	_	13,876	_	22,749	61.0
Process equipment business	11,081	77.7	10,909	78.6	16,912	64.5
Semiconductor equipment	3,079	21.6	2,453	17.7	4,884	50.2
Transfer equipment	3,651	25.6	3,961	28.5	5,289	74.9
Cleaning equipment	1,979	13.9	2,052	14.8	2,564	80.0
Coater	2,371	16.6	2,442	17.6	4,173	58.5
Precision molding dies and plastic moldings business	1,045	7.3	1,155	8.3	1,523	75.8
Surface treatment equipment business	2,136	15.0	1,811	13.1	4,313	42.0

Segment information



	FY2020 3Q	Sales ratio (%)	FY2021 3Q	Sales ratio (%)	Estimates	Achievement ratio (%)
Operating income	1,644	11.5	838	6.0	2,105	39.8
Process equipment business	1,536	10.8	897	6.5	1,711	52.4
Precision molding dies and plastic moldings business	27	0.2	75	0.5	86	87.2
Surface treatment equipment business	82	0.6	△122	△0.9	307	_
Elimination of inter- segment transactions	\triangle 1	_	△11	△0.1	_	_



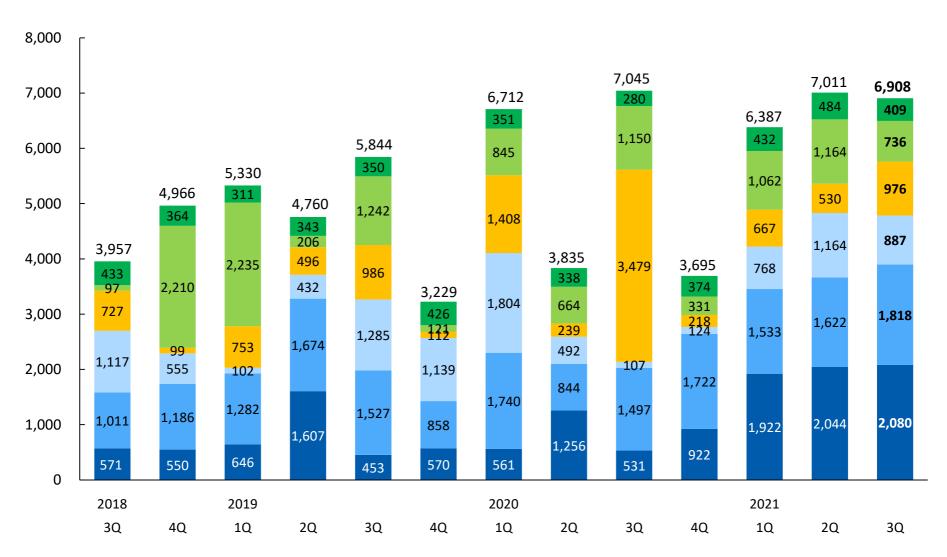


History of Sales Orders



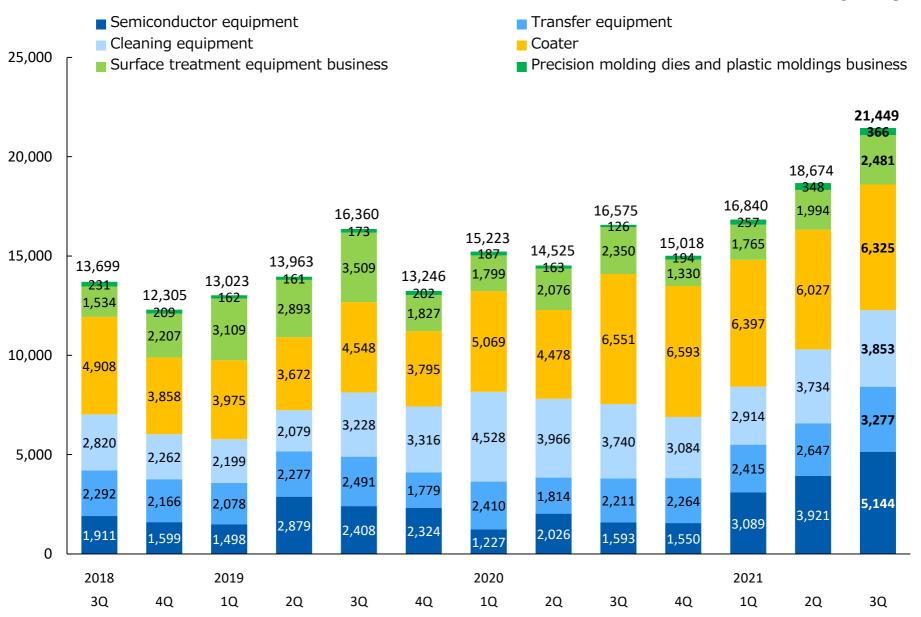
- Semiconductor equipment
- Cleaning equipment
- Surface treatment equipment business

- Transfer equipment
- Coater
- Precision molding dies and plastic moldings business



History of Order Backlog





This material information is made based on the summary of consolidated financial results published on November 12, 2021.

Accordingly, these forward-looking figures contain uncertain elements and risk, and actual results may differ from these forecasts for a variety of reasons.

Although carefull attention shall be paid to all contents, we appreciate your understanding that there is a risk in investing in stocks.

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TAZMO